

# AP7217

#### 500mA CMOS LDO

#### Features

- Very Low Dropout Voltage
- Low Current Consumption: Typ. 50µA
- Output Voltage: 3.3V
- Guaranteed 500mA (min) Output
- Input Range up to 5.5V
- Current Limiting
- Stable with either electrolytic capacitor or low-ESR MLCC (multi-layer ceramic capacitor) Low Temperature Coefficient
- SOP-8L: Available in "Green" Molding Compound (no Br, Sb)
- Lead Free Finish / RoHS Compliant (Note 1)

### Applications

- HD/BlueRay DVD & MP3/4 Players
- Mobile Handsets and Smartphones
- Digital Still Camera
- Hand-Held Computers

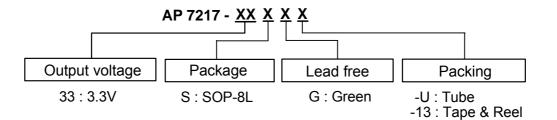
### **Ordering Information**

# General Description

The AP7217 low-dropout linear regulator operates from a 3.3V to 5.5V supply and delivers a guaranteed 500mA (min) continuous load current.

The high-accuracy output voltage is preset to an internally trimmed voltage. An active-low open-drain reset output remains asserted for at least 20ms (TYP) after output voltage reaches  $V_{\text{DF}}$ .

The space-saving SOP-8L package is suitable for "pocket" and hand-held applications.



Note: 1. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see EU Directive Annex Notes 5 and 7.

	Baakaga		Packaging	1	Гube	13" Tape and Reel		
	Device	Package Code	Packaging (Note 2)	Quantity	Part Number Suffix	Quantity	Part Number Suffix	
Pb,	AP7217-XXS	S	SOP-8L	100	-U	2500/Tape & Reel	-13	

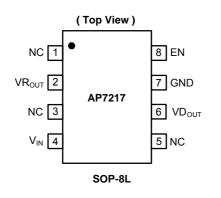
Note: 2. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be on our website at http://www.diodes.com/datasheets/ap02001.pdf.

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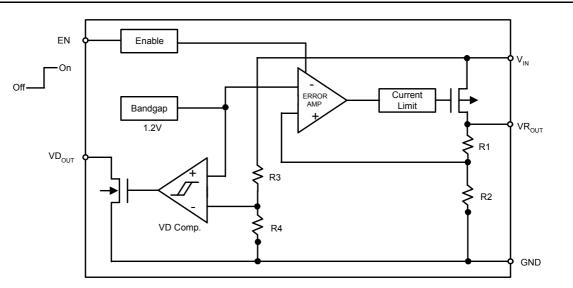
## **Pin Assignments**



## **Pin Descriptions**

Pin Name	Pin No.	Function	
NC	1	No Connection	
VR <sub>OUT</sub>	2	Voltage Output	
NC	3	No Connection	
V <sub>IN</sub>	4	Supply Voltage	
NC	5	No connection	
VD <sub>OUT</sub>	6	V <sub>D</sub> Output (Reset on I/P)	
GND	7	Ground	
EN	8	Enable (V <sub>R</sub> On/Off)	

## **Block Diagram**



## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD MM	Machine Model ESD Protection	450	V
V <sub>IN</sub>	Input Voltage	+6	V
I <sub>OUT</sub>	Output Current	$P_D/(V_{IN}-V_O)$	mA
VR <sub>OUT</sub>	Output Voltage	GND - 0.3 ~ V <sub>IN</sub> + 0.3	V
TJ	Operating Junction Temperature Range	-40 to +125	°C
T <sub>J(MAX)</sub>	Maximum Junction Temperature	150	°C
PD	Internal Power Dissipation	1.2	W



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## **Recommended Operating Conditions**

Symbol	Parameter	Min	Max	Unit
V <sub>IN</sub>	Input Voltage	3.3	5.5	V
lout	Output Current	0	500	mA
T <sub>A</sub> Operating Ambient Temperature		-40	85	°C

## **Electrical Characteristics**

1	T. = 25°C	$C_{\rm m} = 1 \mu E$	$C_{avr} = 1$	$F V_{-1} = f$	2V unless	otherwise noted)
	$I_A = 25 C_2$	$C_{\rm IN} = 1 \mu r$	$, C_{OUT} - IP$	□, v <sub>EN</sub> -4	∠v, unicss	otherwise noted)

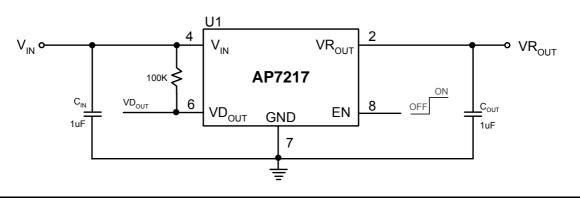
Symbol	Parameter	Test Conditions		Min	Тур.	Max	Unit
Ι <sub>Q</sub>	Quiescent Current	I <sub>O</sub> = 0mA		-	50	70	μA
I <sub>STB</sub>	Standby Current	VEN = Off V <sub>IN</sub> = 5.0V			15	30	μA
VR <sub>OUT</sub>	Output Voltage Accuracy	I <sub>O</sub> = 30mA, V <sub>IN</sub> = 5V		3.234	3.300	3.366	V
VINOUT	VR <sub>OUT</sub> Temperature Coefficient	-40°C to 85°C, I <sub>OUT</sub> = 30mA			±100		ppm / °C
V <sub>DROPOUT</sub>	Dropout Voltage	I <sub>OUT</sub> = 100mA			100	250	mV
I <sub>OUT</sub>	Output Current	V <sub>IN</sub> = 5.3V		500			mA
I <sub>LIMIT</sub>	Current Limit	V <sub>IN</sub> = 5.3V			600		mA
I <sub>short</sub>	Short Circuit Current	V <sub>IN</sub> = 5.3V			50		mA
$\Delta V_{\text{LINE}} / \Delta V_{\text{IN}} / V R_{\text{OUT}}$	Line Regulation	4.3V ≤ V <sub>IN</sub> ≤ 5.5V; I <sub>OUT</sub> = 30mA			0.01	±0.2	%/V
$\Delta VR_{OUT}$	Load Regulation	$1\text{mA} \le I_{\text{OUT}} \le 100\text{mA}, V_{\text{IN}} = 5.3\text{V}$			15	50	mV
PSRR	Power Supply Rejection	V <sub>IN</sub> = 4.3V+0.5Vp-pAC, I <sub>OUT</sub> = 50mA	F= 1KHz		55		dB
V <sub>EH</sub>	CN Innut Threehold	Output ON		1.6			V
V <sub>EL</sub>	EN Input Threshold	Output OFF				0.25	V
I <sub>EN</sub>	Enable Pin Current			-0.1		0.1	μA
V <sub>DF</sub>	Detect fall voltage			3.83	3.91	3.98	V
V <sub>Hysteresis</sub>	V <sub>D</sub> Hysteresis Range			V <sub>DF</sub> x1.02	V <sub>DF</sub> x1.05	V <sub>DF</sub> x1.08	V
IVD <sub>OUT</sub> VD Supply Current		VD <sub>OUT</sub> = 0.5V V <sub>IN</sub> = 2.0V 3.0V			20 30		mA
t <sub>RP</sub>	V <sub>DOUT</sub> Delay Time	V <sub>IN</sub> = 1.8V to VDF+1V		10	20	40	mSec
θ <sub>JA</sub>	Thermal Resistance				134		°C/W
θ <sub>JC</sub> Thermal Resistance		SOP-8L (Note 3)			28		°C/W

Note: 3. Test conditions for SOP-8L: Devices mounted on FR-4 PC board, MRP, 2oz copper layout, calibrate at T<sub>J</sub>=150 °C, measure at T<sub>A</sub>=25°C, minimum recommended pad layout

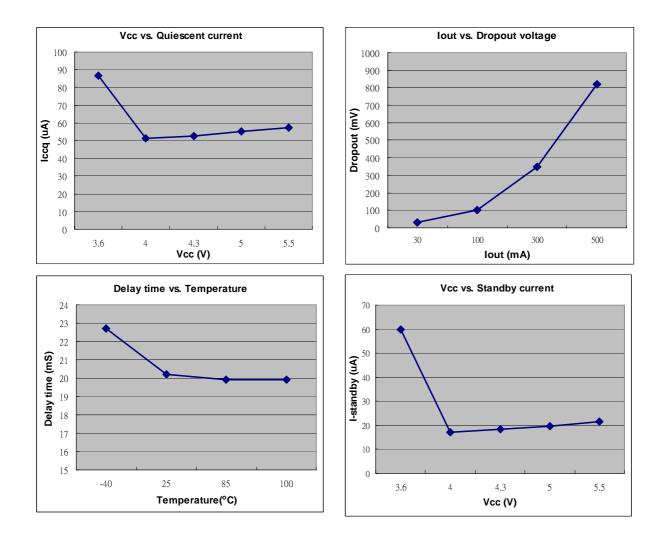


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## **Typical Application**

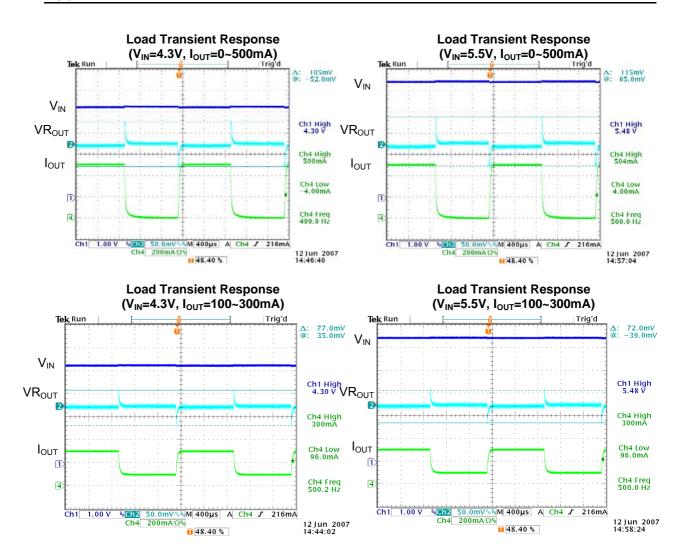


## **Typical Performance Characteristics**





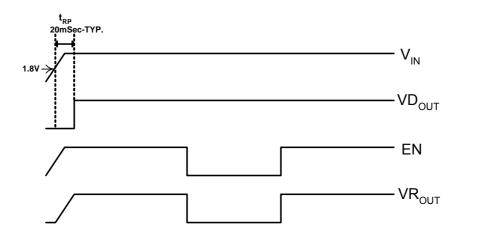






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### **Timing Diagram**



### **Application Note**

#### Input Capacitor

A 1µF ceramic capacitor is recommended to connect between IN and GND pins to decouple input power supply glitch and noise. The amount of the capacitance may be increased without limit. A lower ESR (Equivalent Series Resistance) capacitor allows the use of less capacitance, while higher ESR type requires more capacitance. This input capacitor must be located as close as possible to the device to assure input stability and less noise. For PCB layout, a wide copper trace is required for both IN and GND.

#### **Output Capacitor**

The output capacitor is required to stabilize and help the transient response of the LDO. The AP7217 is designed to have excellent transient response for most applications with a small amount of output capacitance. The AP7217 is stable with any small ceramic output capacitors of  $1.0\mu$ F or higher value, and the temperature coefficients of X7R or X5R type. Additional capacitance helps to reduce undershoot and overshoot during transient. For PCB layout, the output capacitor must be placed as close as possible to OUT and GND pins, and keep the leads as short as possible.

#### **ENABLE/SHUTDOWN** Operation

The AP7217 is turned on by setting the EN pin high, and is turned off by pulling it low. If this feature is not used, the EN pin should be tied to IN pin to keep the regulator output on at all time. To ensure proper operation, the signal source used to drive the EN pin must be able to swing above and below the specified turn-on/off voltage thresholds listed in the Electrical Characteristics section under V<sub>IL</sub> and V<sub>IH</sub>.

	VR <sub>OUT</sub>	VD <sub>OUT</sub>
EN=0	0V	φ
EN=1	3.3V	φ

#### **Current Limit Protection**

When output current at OUT pin is higher than current limit threshold, the current limit protection will be triggered and clamp the output current to approximately 600mA to prevent over-current and to protect the regulator from damage due to overheating.

#### Short circuit protection

When VRout pin is shorted to GND or VRout voltage is less than 200mV, short circuit protection will be triggered and clamp the output current to approximately 50mA.

#### VD<sub>OUT</sub> (reset output)

---Open-Drain Active-Low reset output---

In general,  $VD_{\text{OUT}}$  is pulled up by a resistor (100Kohm) to  $V_{\text{IN}}$ . The AP7217 microprocess (uP) supervisory circuitry asserts a guaranteed logic-low reset during power-up and power-down. Reset is asserted asserts when  $V_{\text{IN}}$  is below the reset threshold and remain asserted for at least  $t_{\text{RP}}$  after  $V_{\text{IN}}$  rises above the reset threshold.

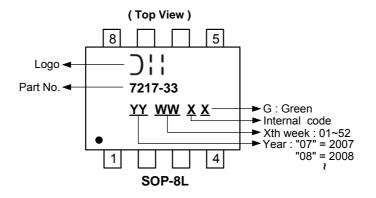
As long as  $V_{\rm IN}$  is lower than the reset threshold,  $VD_{\rm OUT}$  remains at logic "0". When  $V_{\rm IN}$  become higher than  $V_{\rm TH}$ , a logic "1" is asserted after a time delay defined by  $t_{\rm RP}.$ 



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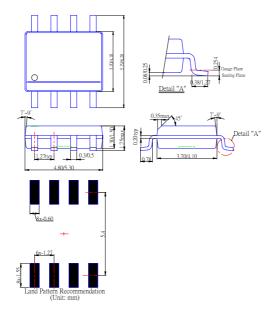
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### **Marking Information**



### Package Information (unit: mm)

Package type: SOP-8L



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